

Regulating Pulse Width Modulators

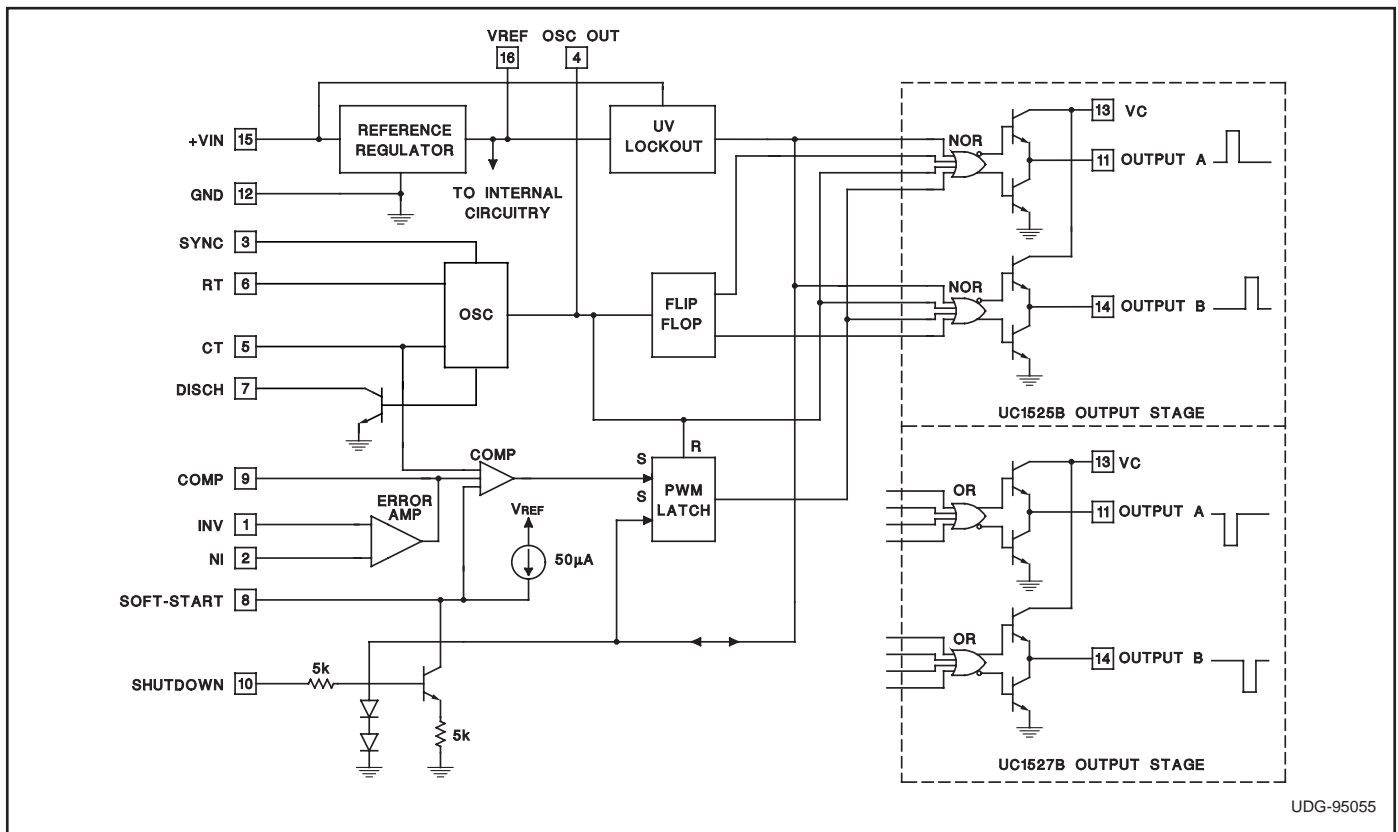
FEATURES

- 8 to 35V Operation
- 5.1V Buried Zener Reference Trimmed to $\pm 0.75\%$
- 100Hz to 500kHz Oscillator Range
- Separate Oscillator Sync Terminal
- Adjustable Deadtime Control
- Internal Soft-Start
- Pulse-by-Pulse Shutdown
- Input Undervoltage Lockout with Hysteresis
- Latching PWM to Prevent Multiple Pulses
- Dual Source/Sink Output Drivers
- Low Cross Conduction Output Stage
- Tighter Reference Specifications

DESCRIPTION

The UC1525B/1527B series of pulse width modulator integrated circuits are designed to offer improved performance and lowered external parts count when used in designing all types of switching power supplies. The on-chip +5.1V buried zener reference is trimmed to $\pm 0.75\%$ and the input common-mode range of the error amplifier includes the reference voltage, eliminating external resistors. A sync input to the oscillator allows multiple units to be slaved or a single unit to be synchronized to an external system clock. A single resistor between the CT and the discharge terminals provide a wide range of dead time adjustment. These devices also feature built-in soft-start circuitry with only an external timing capacitor required. A shutdown terminal controls both the soft-start circuitry and the output stages, providing instantaneous turn off through the PWM latch with pulsed shutdown, as well as soft-start recycle with longer shutdown commands. These functions are also controlled by an undervoltage lockout which keeps the outputs off and the soft-start capacitor discharged for sub-normal input voltages. This lockout circuitry includes approximately 500mV of hysteresis for jitter-free operation. Another feature of these PWM circuits is a latch following the comparator. Once a PWM pulse has been terminated for any reason, the outputs will remain off for the duration of the period. The latch is reset with each clock pulse. The output stages are totem-pole designs capable of sourcing or sinking in excess of 200mA. The UC1525B output stage features NOR logic, giving a LOW output for an OFF state. The UC1527B utilizes OR logic which results in a HIGH output level when OFF.

BLOCK DIAGRAM



UDG-95055

ABSOLUTE MAXIMUM RATINGS

Supply Voltage, (+VIN)	+40V
Collector Supply Voltage (VC)	+40V
Logic Inputs	-0.3V to +5.5V
Analog Inputs	-0.3V to VIN
Output Current, Source or Sink	500mA
Reference Output Current	50mA
Oscillator Charging Current	5mA
Power Dissipation at T _A = +25°C	1000mW
Power Dissipation at T _C = +25°C	2000mW
Operating Junction Temperature	-55°C to +150°C
Storage Temperature Range	-65°C to +150°C
Lead Temperature (Soldering, 10 sec.)	+300°C

All currents are positive into, negative out of the specified terminal. Consult Packaging Section of Databook for thermal limitations and considerations of packages.

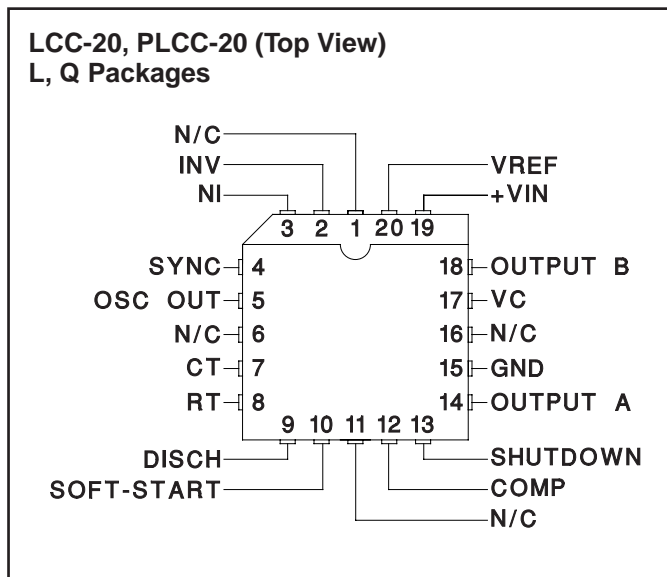
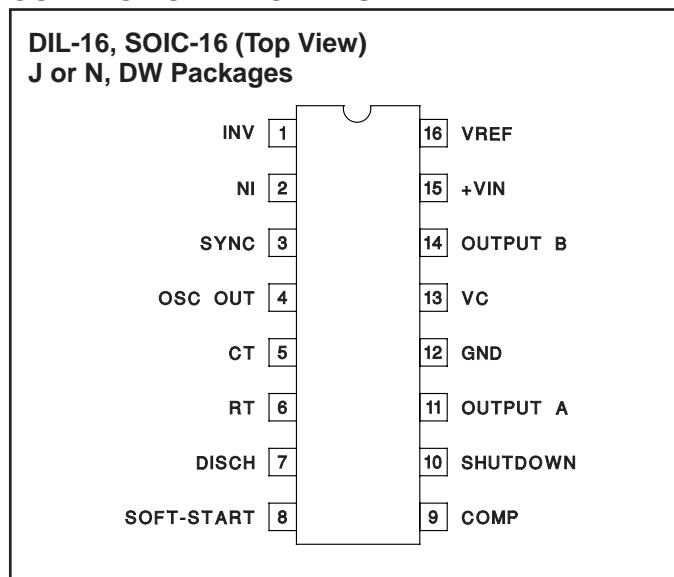
RECOMMENDED OPERATING CONDITIONS

(Note 1)

Input Voltage (+VIN)	+8V to +35V
Collector Supply Voltage (VC)	+4.5V to +35V
Sink/Source Load Current (steady state)	0 to 100mA
Sink/Source Load Current (peak)	0 to 400mA
Reference Load Current	0 to 20mA
Oscillator Frequency Range	100Hz to 400kHz
Oscillator Timing Resistor	2kΩ to 150kΩ
Oscillator Timing Capacitor	0.001μF to 0.1μF
Dead Time Resistor Range	0Ω to 500Ω

Note 1: Range over which the device is functional and parameter limits are guaranteed.

CONNECTION DIAGRAMS



ELECTRICAL CHARACTERISTICS: Unless otherwise stated, these specifications apply for T_A = -55°C to +125°C for the UC1525B and UC1527B; -40°C to +85°C for the UC2525B and UC2527B; 0°C to +70°C for the UC3525B and UC3527B; +VIN = 20V, T_A = T_J.

PARAMETER	TEST CONDITIONS	UC1525B/UC2525B UC1527B/UC2527B			UC3525B UC3527B			UNITS
		MIN	TYP	MAX	MIN	TYP	MAX	
Reference Section								
Output Voltage	T _J = 25°C	5.062	5.10	5.138	5.036	5.10	5.164	V
Line Regulation	V _{IN} = 8V to 35V		5	10		5	10	mV
Load Regulation	I _L = 0mA to 20mA		7	15		7	15	mV
Temperature Stability (Note 2)	Over Operating Range		10	50		10	50	mV
Total Output Variation	Line, Load, and Temperature	5.036		5.164	5.024		5.176	V
Short Circuit Current	V _{REF} = 0, T _J = 25°C		80	100		80	100	mA
Output Noise Voltage (Note 2)	10Hz ≤ f ≤ 10kHz, T _J = 25°C		40	200		40	200	μVrms
Long Term Stability (Note 2)	T _J = 125°C, 1000 Hrs.		3	10		3	10	mV

ELECTRICAL CHARACTERISTICS: Unless otherwise stated, these specifications apply for $T_A = -55^{\circ}\text{C}$ to $+125^{\circ}\text{C}$ for the UC1525B and UC1527B; -40°C to $+85^{\circ}\text{C}$ for the UC2525B and UC2527B; 0°C to $+70^{\circ}\text{C}$ for the UC3525B and UC3527B; $+V_{IN} = 20\text{V}$, $T_A = T_J$.

PARAMETER	TEST CONDITIONS	UC1525B/UC2525B UC1527B/UC2527B			UC3525B UC3527B			UNITS
		MIN	TYP	MAX	MIN	TYP	MAX	
Oscillator Section (Note 3)								
Initial Accuracy (Notes 2 & 3)	$T_J = 25^{\circ}\text{C}$		± 2	± 6		± 2	± 6	%
Voltage Stability (Notes 2 & 3)	$V_{IN} = 8\text{V}$ to 35V		± 0.3	± 1		± 1	± 2	%
Temperature Stability (Note 2)	Over Operating Range		± 3	± 6		± 3	± 6	%
Minimum Frequency	$R_T = 200\text{k}\Omega$, $C_T = 0.1\mu\text{F}$			120			120	Hz
Maximum Frequency	$R_T = 2\text{k}\Omega$, $C_T = 470\text{pF}$	400			400			kHz
Current Mirror	$I_{RT} = 2\text{mA}$	1.7	2.0	2.2	1.7	2.0	2.2	mA
Clock Amplitude (Notes 2 & 3)		3.0	3.5		3.0	3.5		V
Clock Width (Notes 2 & 3)	$T_J = 25^{\circ}\text{C}$	0.3	0.5	1.0	0.3	0.5	1.0	μs
Sync Threshold		1.2	2.0	2.8	1.2	2.0	2.8	V
Sync Input Current	Sync Voltage = 3.5V		1.0	2.5		1.0	2.5	mA
Error Amplifier Section (VCM = 5.1V)								
Input Offset Voltage			0.5	5		2	10	mV
Input Bias Current			1	10		1	10	μA
Input Offset Current				1			1	μA
DC Open Loop Gain	$R_L \geq 10\text{ Meg}\Omega$	60	75		60	75		dB
Gain-Bandwidth Product (Note 2)	$A_V = 0\text{dB}$, $T_J = 25^{\circ}\text{C}$	1	2		1	2		MHz
Output Low Level			0.2	0.5		0.2	0.5	V
Output High Level		3.8	5.6		3.8	5.6		V
Common Mode Rejection	$V_{CM} = 1.5\text{V}$ to 5.2V	60	75		60	75		dB
Supply Voltage Rejection	$V_{IN} = 8\text{V}$ to 35V	50	60		50	60		dB
PWM Comparator								
Minimum Duty Cycle				0			0	%
Maximum Duty Cycle (Note 3)		45	49		45	49		%
Input Threshold (Note 3)	Zero Duty Cycle	0.7	0.9		0.7	0.9		V
Input Threshold (Note 3)	Maximum Duty Cycle		3.3	3.6		3.3	3.6	V
Input Bias Current (Note 2)			0.05	1.0		0.05	1.0	μA
Shutdown Section								
Soft Start Current	$V_{SHUTDOWN} = 0\text{V}$, $V_{SOFTSTART} = 0\text{V}$	25	50	80	25	50	80	μA
Soft Start Low Level	$V_{SHUTDOWN} = 2.5\text{V}$		0.4	0.7		0.4	0.7	V
Shutdown Threshold	To outputs, $V_{SOFTSTART} = 5.1\text{V}$, $T_J = 25^{\circ}\text{C}$	0.6	0.8	1.0	0.6	0.8	1.0	V
Shutdown Input Current	$V_{SHUTDOWN} = 2.5\text{V}$		0.4	1.0		0.4	1.0	mA
Shutdown Delay (Note 2)	$V_{SHUTDOWN} = 2.5\text{V}$, $T_J = 25^{\circ}\text{C}$		0.2	0.5		0.2	0.5	μs
Output Drivers (Each Output) (Vc = 20V)								
Output Low Level	$I_{SINK} = 20\text{mA}$		0.2	0.4		0.2	0.4	V
	$I_{SINK} = 100\text{mA}$		1.0	2.0		1.0	2.0	V
Output High Level	$I_{SOURCE} = 20\text{mA}$	18	19		18	19		V
	$I_{SOURCE} = 100\text{mA}$	17	18		17	18		V
Undervoltage Lockout	V_{COMP} and $V_{SOFTSTART} = \text{High}$	6	7	8	6	7	8	V
Collector Leakage	$V_C = 35\text{V}$			200			200	μA

ELECTRICAL CHARACTERISTICS: Unless otherwise stated, these specifications apply for $T_A = -55^\circ\text{C}$ to $+125^\circ\text{C}$ for the UC1525B and UC1527B; -40°C to $+85^\circ\text{C}$ for the UC2525B and UC2527B; 0°C to $+70^\circ\text{C}$ for the UC3525B and UC3527B; $+V_{IN} = 20\text{V}$, $T_A = T_J$.

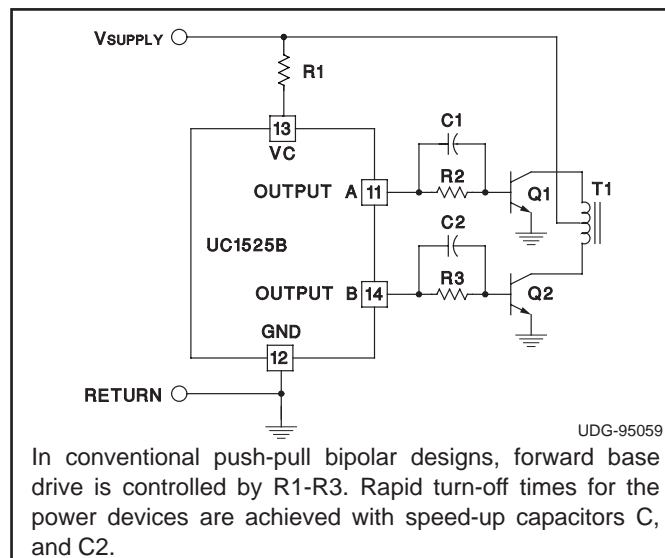
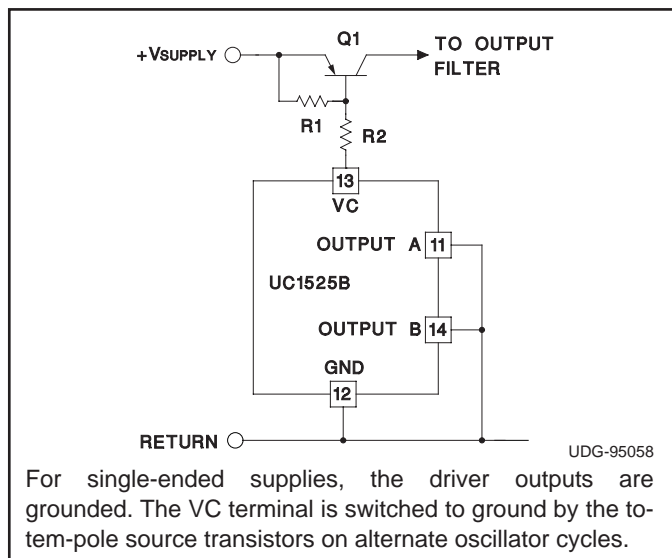
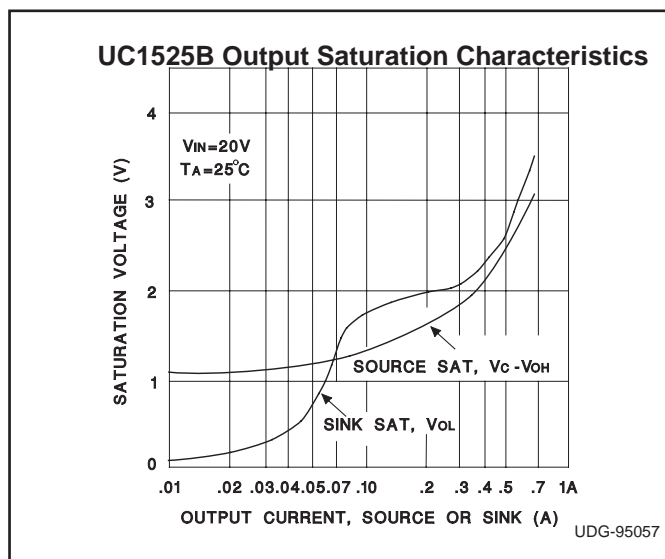
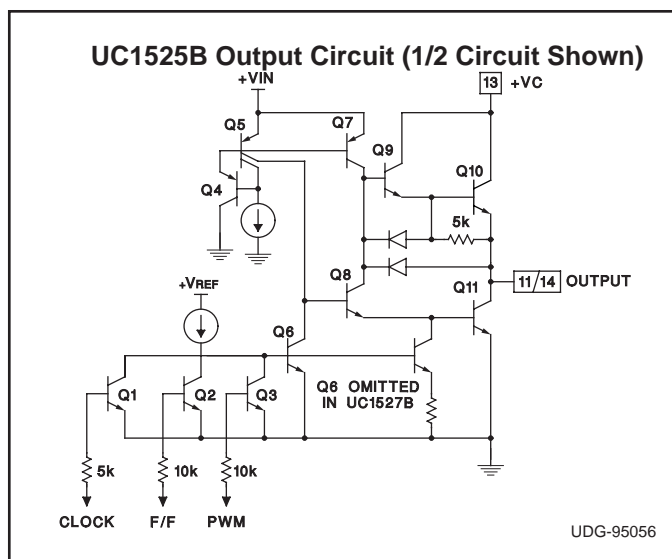
PARAMETER	TEST CONDITIONS	UC1525B/UC2525B UC1527B/UC2527B			UC3525B UC3527B			UNITS
		MIN	TYP	MAX	MIN	TYP	MAX	
Output Drivers (Each Output) ($V_C = 20\text{V}$) (cont.)								
Rise Time (Note 2)	$C_L = 1\text{nF}$, $T_J = 25^\circ\text{C}$		100	600		100	600	ns
Fall Time (Note 2)	$C_L = 1\text{nF}$, $T_J = 25^\circ\text{C}$		50	300		50	300	ns
Cross conduction charge	Per cycle, $T_J = 25^\circ\text{C}$		30			30		nc
Total Standby Current								
Supply Current	$V_{IN} = 35\text{V}$		14	20		14	20	mA

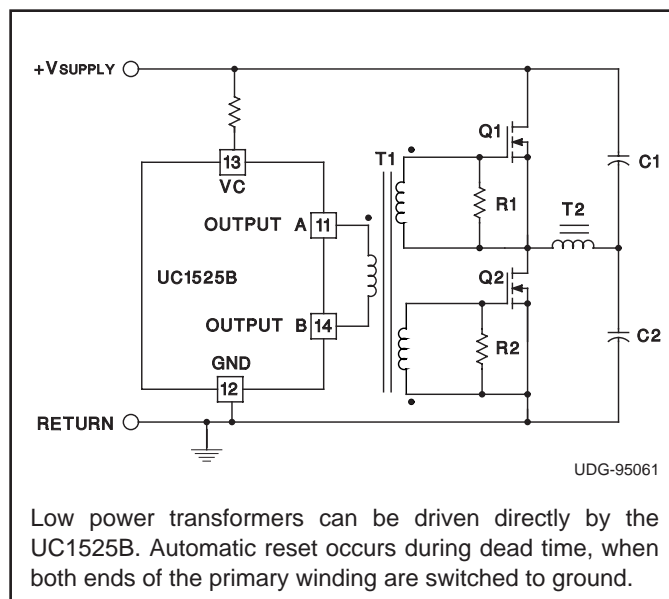
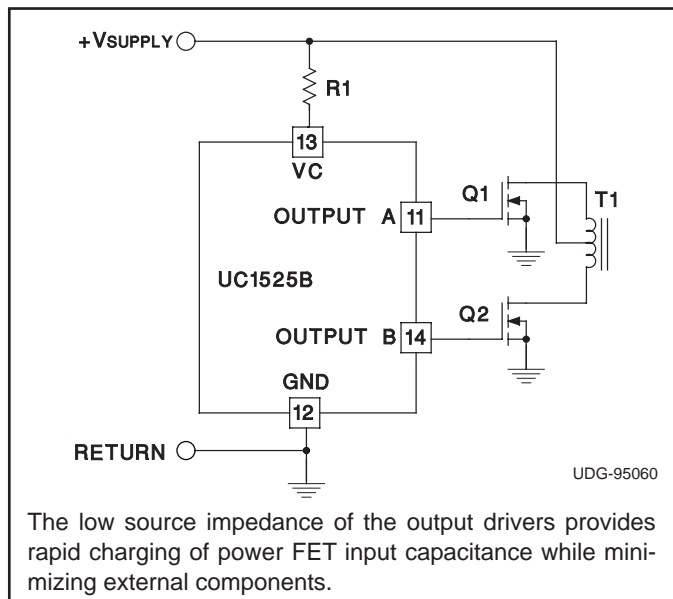
Note 2: Ensured by design. Not 100% tested in production.

Note 3: Tested at $f_{osc} = 40\text{kHz}$ ($R_T = 3.6\text{k}\Omega$, $C_T = 0.01\mu\text{F}$, $R_D = 0\Omega$). Approximate oscillator frequency is defined by:

$$f = \frac{1}{C_T \cdot (0.7 \cdot R_T + 3R_D)}$$

PRINCIPLES OF OPERATION AND TYPICAL CHARACTERISTICS





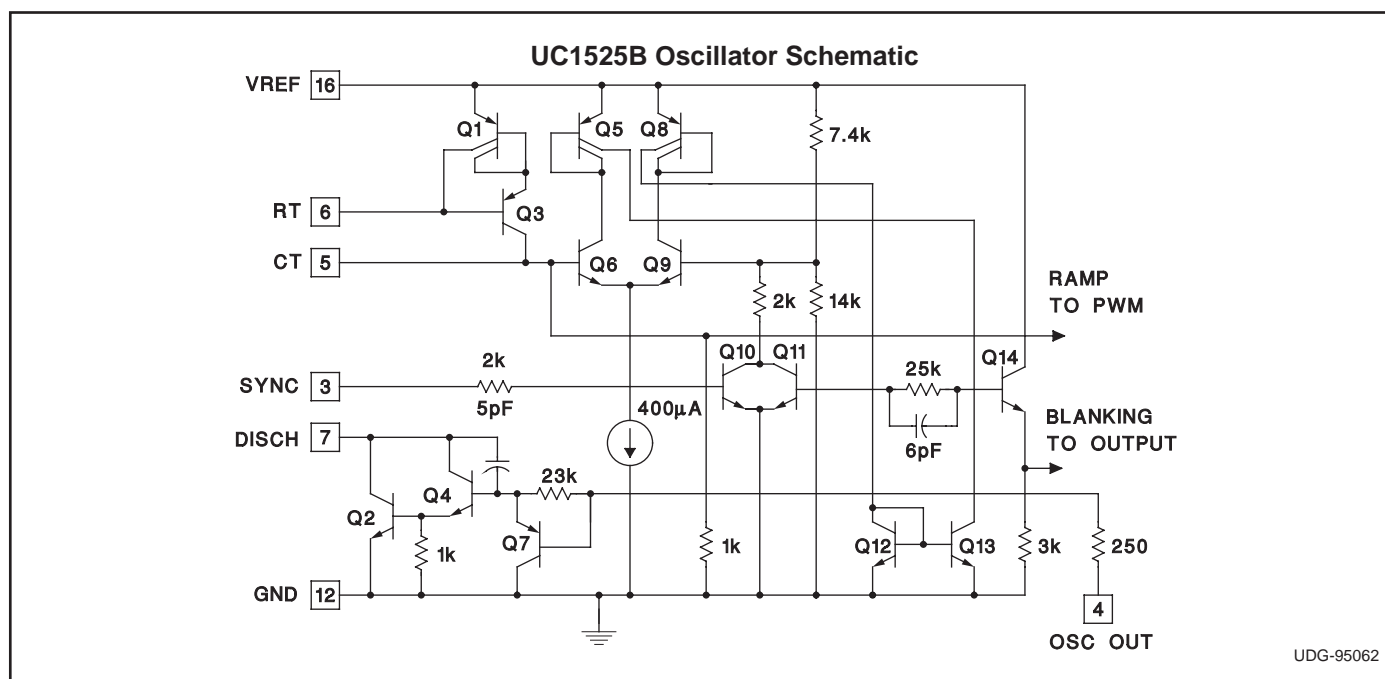
PRINCIPLES OF OPERATION AND TYPICAL CHARACTERISTICS

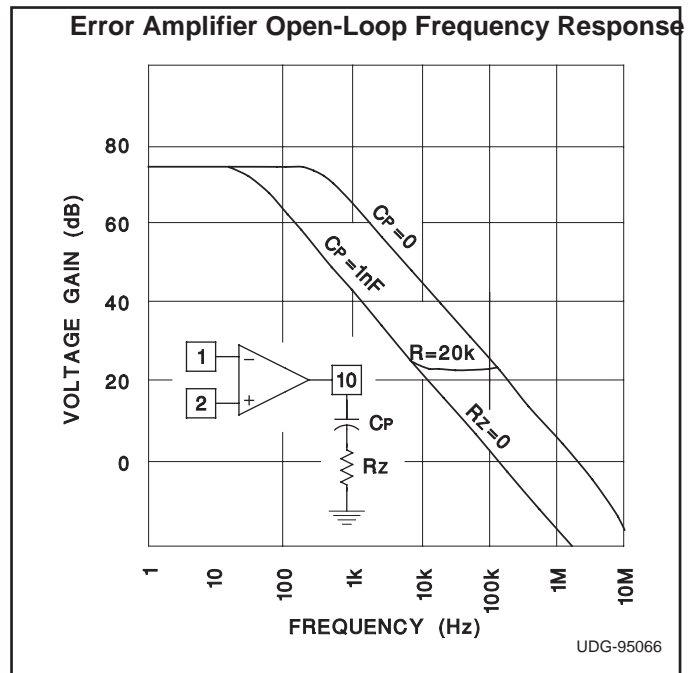
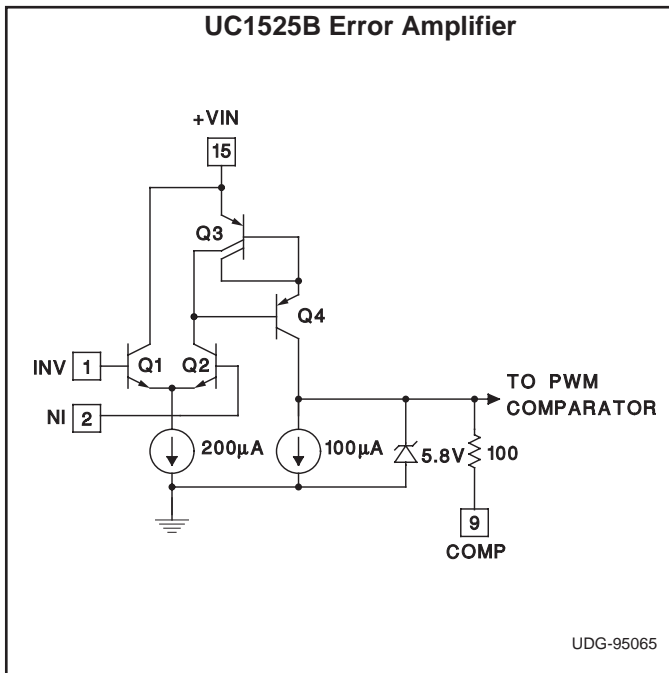
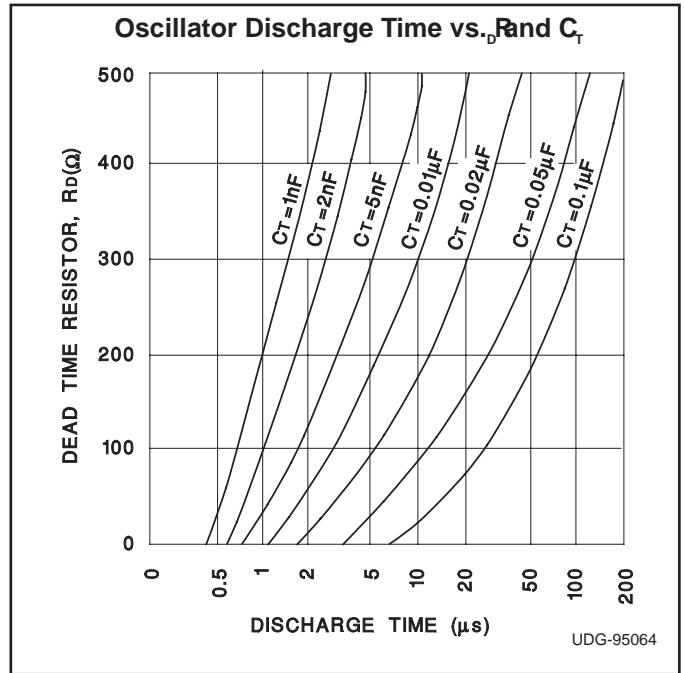
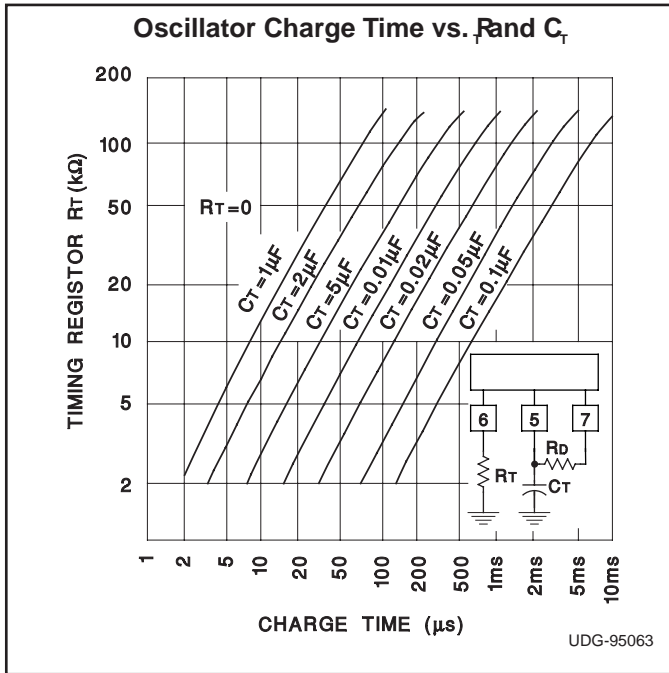
Shutdown Options (See Block Diagram)

Since both the compensation and soft-start terminals (Pins 9 and 8) have current source pull-ups, either can readily accept a pull-down signal which only has to sink a maximum of 100 μ A to turn off the outputs. This is subject to the added requirement of discharging whatever external capacitance may be attached to these pins.

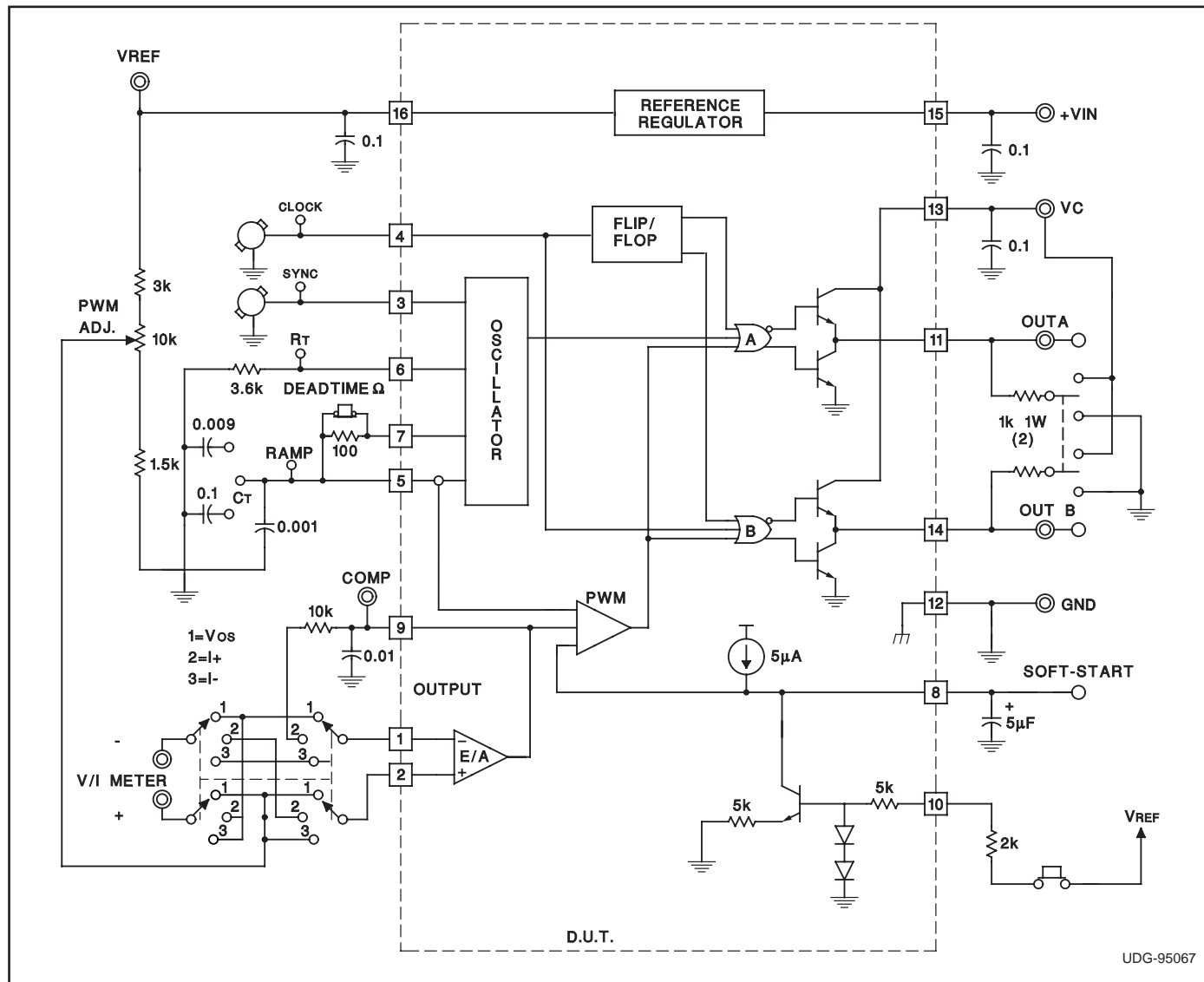
An alternate approach is the use of the shutdown circuitry of Pin 10 which has been improved to enhance the available shutdown options. Activating this circuit by ap-

plying a positive signal on Pin 10 performs two functions: the PWM latch is immediately set providing the fastest turn-off signal to the external soft-start capacitor. If the shutdown command is short, the PWM signal is terminated without significant discharge of the soft-start capacitor, thus, allowing, for example, a convenient implementation of pulse-by-pulse current limiting. Holding Pin 10 high for a longer duration, however, will ultimately discharge this external capacitor, recycling slow turn-on upon release.





LAB TEST FIXTURE



PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
5962-8951105EA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-8951105EA UC1525BJ/883B	Samples
UC1525BJ	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	UC1525BJ	Samples
UC1525BJ883B	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-8951105EA UC1525BJ/883B	Samples
UC2525BDWTR	ACTIVE	SOIC	DW	16	2000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	UC2525BDW	Samples
UC3525BDW	ACTIVE	SOIC	DW	16	40	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	0 to 70	UC3525BDW	Samples
UC3525BDWG4	ACTIVE	SOIC	DW	16	40	TBD	Call TI	Call TI	0 to 70		Samples
UC3525BDWTR	ACTIVE	SOIC	DW	16	2000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	0 to 70	UC3525BDW	Samples
UC3525BN	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	UC3525BN	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer:The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF UC1525B, UC3525B :

- Catalog : [UC3525B](#)

- Military : [UC1525B](#)

- Space : [UC1525B-SP](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product

- Military - QML certified for Military and Defense Applications

- Space - Radiation tolerant, ceramic packaging and qualified for use in Space-based application

TAPE AND REEL INFORMATION

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
UC2525BDWTR	SOIC	DW	16	2000	330.0	16.4	10.75	10.7	2.7	12.0	16.0	Q1
UC3525BDWTR	SOIC	DW	16	2000	330.0	16.4	10.75	10.7	2.7	12.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
UC2525BDWTR	SOIC	DW	16	2000	356.0	356.0	35.0
UC3525BDWTR	SOIC	DW	16	2000	356.0	356.0	35.0

TUBE


*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
UC3525BDW	DW	SOIC	16	40	507	12.83	5080	6.6
UC3525BN	N	PDIP	16	25	506	13.97	11230	4.32

GENERIC PACKAGE VIEW

DW 16

SOIC - 2.65 mm max height

7.5 x 10.3, 1.27 mm pitch

SMALL OUTLINE INTEGRATED CIRCUIT

This image is a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.



4224780/A



DW0016A

PACKAGE OUTLINE

SOIC - 2.65 mm max height

SOIC



4220721/A 07/2016

NOTES:

1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.
5. Reference JEDEC registration MS-013.

EXAMPLE BOARD LAYOUT

DW0016A

SOIC - 2.65 mm max height

SOIC



LAND PATTERN EXAMPLE
SCALE:7X



SOLDER MASK DETAILS

4220721/A 07/2016

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DW0016A

SOIC - 2.65 mm max height

SOIC



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:7X

4220721/A 07/2016

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

J (R-GDIP-T**)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



DIM \ PINS **	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)



4040083/F 03/03

- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - This package is hermetically sealed with a ceramic lid using glass frit.
 - Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
 - Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 - The 20 pin end lead shoulder width is a vendor option, either half or full width.

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#) or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2022, Texas Instruments Incorporated